

DATA SHEET

■ DEVICE NUMBER : ORH-B35A

(For:)

SHEET				_	_						
DATE	1	2	3	4	5	6	7	8	9		CONTENTS
2012.02.08	1.0	1.0	1.0	1.0	1.0	1.0	1.0	1.0	1.0	3	Original Released
								\\			
							. (S		
						\$					
								>			
					1						
	<	4									
<				-0-							

深圳市奥伦德科技有限公司

SHENZHEN ORIENT TECHNOLOGY CO.,LTD.

深圳市宝安区西乡鹤洲鸿图工业园 1 栋

Block 1, Hongtu industry Park, Hezhou, xixiang Town, Baoan district, Shenzhen, P.R.C

Tel: 0755-29681816 29980591

Fax: 0755-29681200

E-Mail:saleselec@ orient-opto.com salesdev@ orient-opto.com

www.orient-opto.com.



ORH-B35A

CONTENTS		
1. Features		2/9
2. Outline dimensions		2/9
3. Applications		3/9
4. Absolute Maximum Ratings		3/9
5. Electro-Optical characteristics		3/9
6. Typical Characteristic Curve		4/9
7. Reliability Test Items and Conditions) <u> </u>	5/9
8. Soldering		6/9
9. Handling		6/9
10. Notes for designing		7/9
11. Storage		7/9
12. Package and Label of Products		7/9
13. Bin Limits		8/9
14. Tapping and packaging specifications		9/9
15. Package Method		9/9

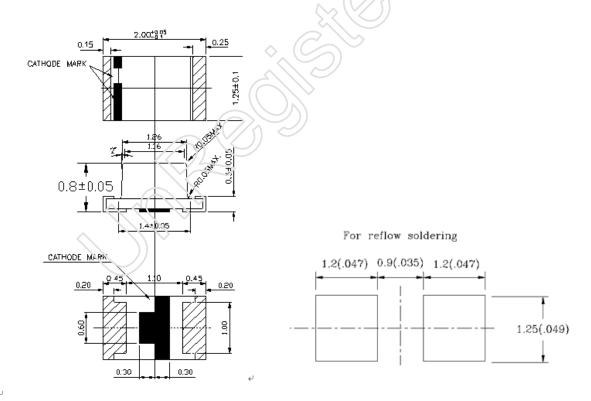


ORH-B35A

Features:

- 1. Chip material: AlInGaN
- 2. Emitted Color: Super Blue
- 3. Lens Appearance: Water Clear.
- 4. Mono-color type.
- 5. 2.0x1.25x0.8mm (0805) standard package.
- 6. Suitable for all SMT assembly methods.
- 7. Compatible with infrared and vapor phase reflow solder process.
- 8. Compatible with automatic placement equipment.
- 9. This product doesn't contain restriction Substance, comply ROHS standard.

●Package Dimensions:



NOTES:

- 1.All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.10mm (0.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.



ORH-B35A

Applications:

- 1. Automotive: Dashboards, stop lamps, turn signals.
- 2. Backlighting: LCDs, Key pads advertising.
- 3. Status indicators: Comsumer & industrial electronics.
- 4. General use.

■ Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	120	mW
Forward Current	I _F	30	mA
Peak Forward Current *1	I _{FP}	100	mA
Operating Temperature	Topr	-25℃~80℃	-
Storage Temperature	Tstg	-30℃~85℃	-
Soldering Temperature	Tsol	See Page 6	-

 $^{*\,1}$ Condition for I_{FP} is pulse of 1/10 duty and 0.1msec wicth.

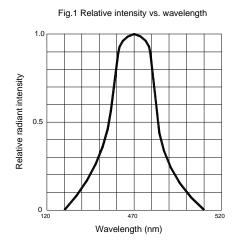
● Electrical and optical characteristics(Ta=25°C)

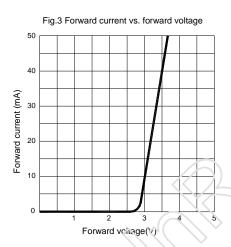
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf	I _F =20mA	-	3.2	3.6	V
Luminous Intensity	lv	I _F =20mA	28	50	-	mcd
Peak Wave Length	λр	I _F =20mA	-	470	-	nm
Dominant Wave Length	λd	I _F =20mA	460	-	470	nm
Spectral Line Half-width	Δλ	I _F =20mA	-	30	-	nm
Veiwing Angle	2θ _{1/2}	I _F =20mA	-	120	-	deg

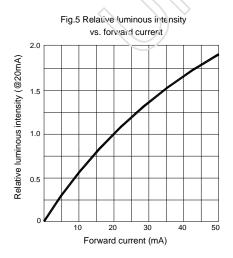


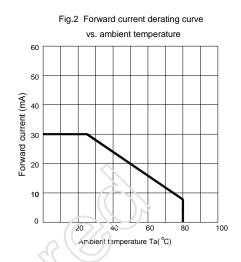
ORH-B35A

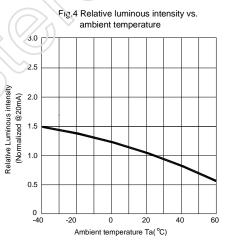
■ Typical Electro-Optical Characteristics Curves

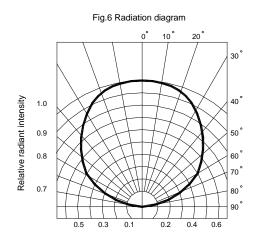














ORH-B35A

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	V _F (V)	I _F =20mA	Over Ux1.2
Reverse current	$I_R(uA)$	V _R =5V	Over Ux2
Luminous intensity	Iv (mcd)	I _F =20mA	Below SX0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	Connect with a power If=20mA Ta=Under room temperature Test time=1,000hrs	0/20
Endurance	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+65°C±5°C RH=90%-95% Test time=240hrs	0/20
Test	High Temperature Storage	MIL-\$1D-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-35°C±5°C Test time=1,000hrs	0/20
		MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	-35°C ~ $+25$ °C ~ $+85$ °C ~ $+25$ °C 60min 20min 60min 20min Test Time=5cycle	0/20
Environmental Test	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-35°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle	0/20
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating: 140°C-160°C, within 2 minutes. Operation heating: 260°C (Max.), within 10seconds. (Max.)	0/20



ORH-B35A

Soldering:

1. Manual Of Soldering

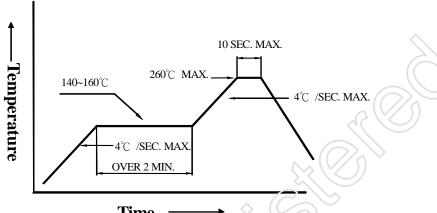
The temperature of the iron tip should not be higher than 300°C (572°F) and Soldering within 3 seconds per solder-land is to be observed.

2. Reflow Soldering

Preheating : 140° C ~ 160° C ± 5° C ,within 2 minutes.

Operation heating: 260°C (Max.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).



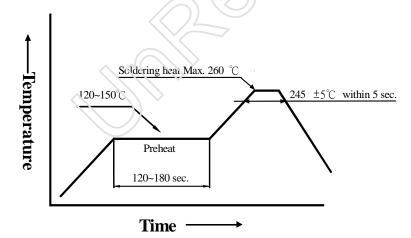
Time

3. DIP soldering (Wave Soldering):

Preheating: 120°C~150°C, within 120~180 sec.

Operation heating: 245°C±5°C within 5 sec 260°C (Max)

Gradual Cooling (Avoid quenching).



Handling:

Care must be taken not to cause to the epoxy resin portion of ORIENTLEDs while it is exposed to high temperature.

Care must be taken not rub the epoxy resin portion of ORIENT LEDs with hard or sharp article such as the sand blast and the metal hook.



ORH-B35A

Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the ORIENT LEDs within the rated figures. Also, caution should be taken not to overload ORIENT LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the ORIENT LEDs.

Storage:

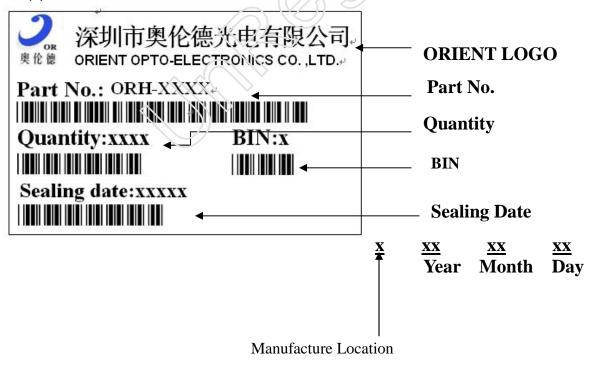
In order to avoid the absorption of moisture, it is recommended to solder ORIENT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5°C-30°C (41°F)Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
- a. Completed within 24 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if: (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions: 12 hours at 60°C±3°C.

Package and Label of Products:

- (1) Package: Products are packed in one bag of 4000 pcs (one taping reel) and a label is attached on each bag.
- (2) Label:





ORH-B35A

Bin Limits

Intensity Bin Limits (At 20mA)

BIN CODE	Min. (mcd)	Max. (mcd)
M	28	42
N	42	63
Р	63	94
Q	94	140

Tolerance for each Bin limit is $\pm 15\%$.

Color Bin Limits (At 20mA)

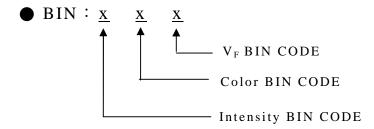
BIN CODE	Min.(v)	Max.(v)
2	455	460
3	460	465
4	465	470
5	470	475

Tolerance for each Bin limit is ± 1 nm.

V_F Bin Limits (At 20mA)

BIN CODE	Min.(v)	Max.(v)
G	2.8	3.0
Н	3.0	3.2
J	3.2	3.4
К	3.4	3.6

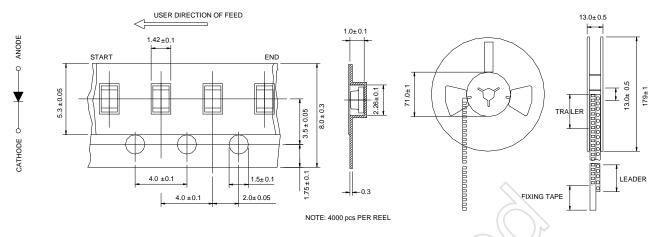
Tolerance for each Bin limit is ± 0.05 V.





ORH-B35A

Tapping and packaging specifications(Units: mm)



● Package Method: (unit:mm)

